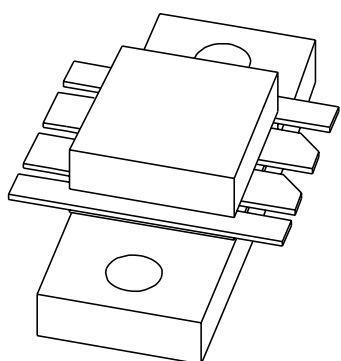


DATA SHEET



BLF246B

VHF push-pull power MOS
transistor

Product specification
Supersedes data of 1999 Jan 28

2000 Feb 04

VHF push-pull power MOS transistor

BLF246B

FEATURES

- High power gain
- Easy power control
- Good thermal stability
- Gold metallization ensures excellent reliability.

APPLICATIONS

Large signal applications in the VHF frequency range.

DESCRIPTION

Silicon N-channel enhancement mode vertical D-MOS push-pull transistor encapsulated in an 8-lead SOT161A balanced flange package with a ceramic cap. All leads are isolated from the flange.

PINNING - SOT161A

PIN	DESCRIPTION
1	source
2	source
3	drain 1
4	gate 1
5	drain 2
6	gate 2
7	source
8	source

PIN CONFIGURATION

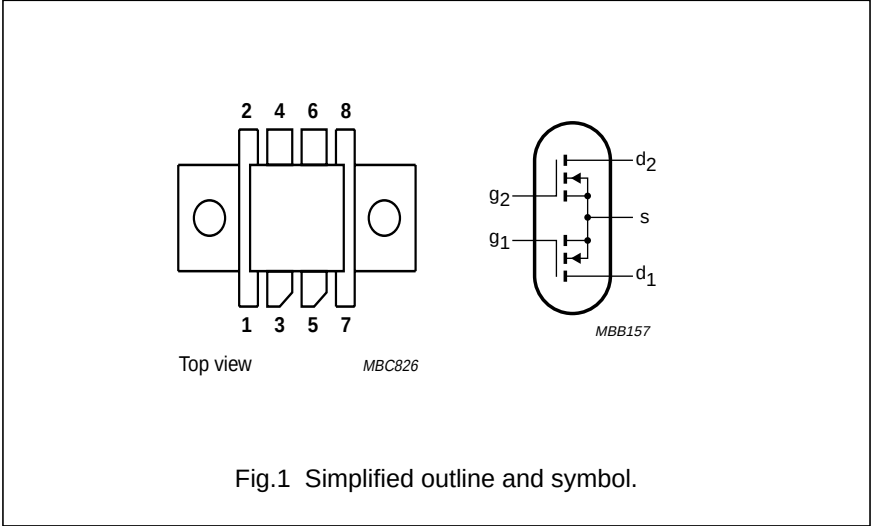


Fig.1 Simplified outline and symbol.

CAUTION

This product is supplied in anti-static packing to prevent damage caused by electrostatic discharge during transport and handling. For further information, refer to Philips specs.: SNW-EQ-608, SNW-FQ-302A, and SNW-FQ-302B.

WARNING

Product and environmental safety - toxic materials

This product contains beryllium oxide. The product is entirely safe provided that the BeO disc is not damaged. All persons who handle, use or dispose of this product should be aware of its nature and of the necessary safety precautions. After use, dispose of as chemical or special waste according to the regulations applying at the location of the user. It must never be thrown out with the general or domestic waste.

QUICK REFERENCE DATA

RF performance at $T_h = 25\text{ }^\circ\text{C}$ in a push-pull common source test circuit.

MODE OF OPERATION	f (MHz)	V_{DS} (V)	P_L (W)	G_p (dB)	η_D (%)
CW, class-AB	175	28	60	>14	>55

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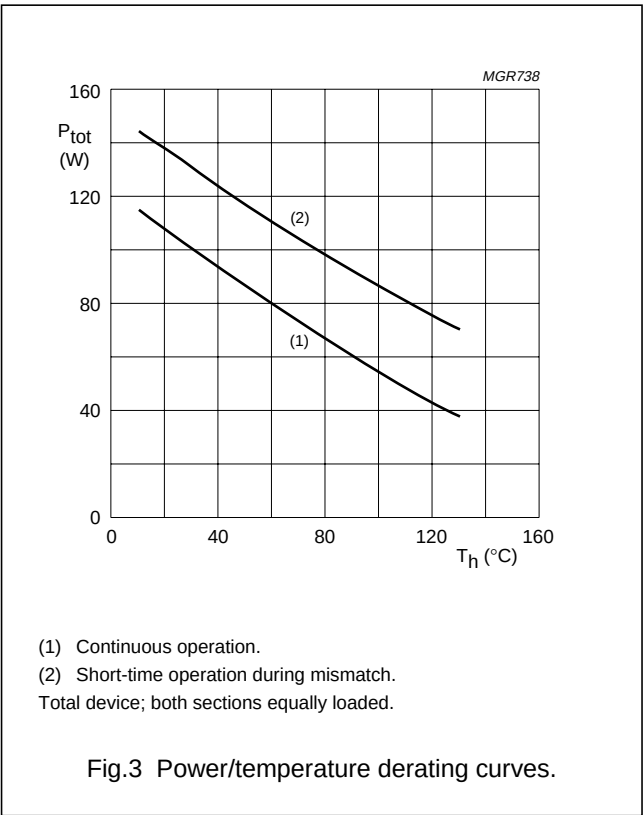
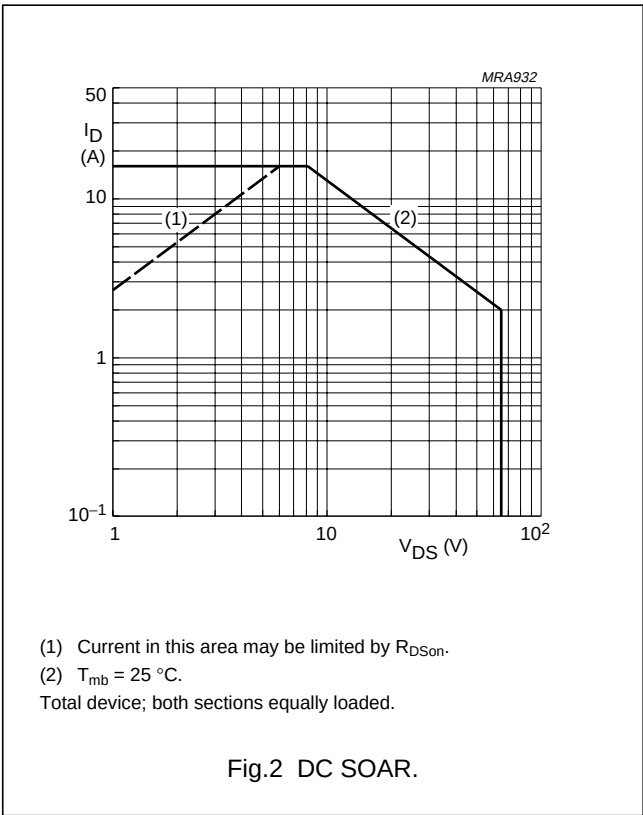
LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
Per transistor section unless otherwise specified					
V _{DS}	drain-source voltage		–	65	V
V _{GS}	gate-source voltage		–	±20	V
I _D	drain current (DC)		–	8	A
P _{tot}	total power dissipation	T _{mb} ≤ 25 °C total device; both sections equally loaded	–	130	W
T _{stg}	storage temperature		–65	+150	°C
T _j	junction temperature		–	200	°C

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th j-mb}	thermal resistance from junction to mounting base	total device; both sections equally loaded	1.35	K/W
R _{th mb-h}	thermal resistance from mounting base to heatsink	total device; both sections equally loaded	0.25	K/W



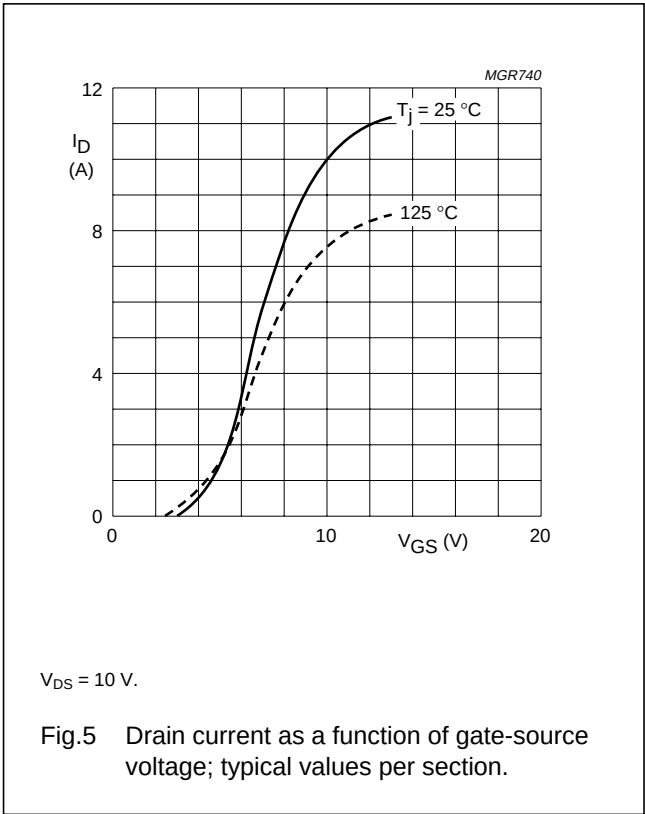
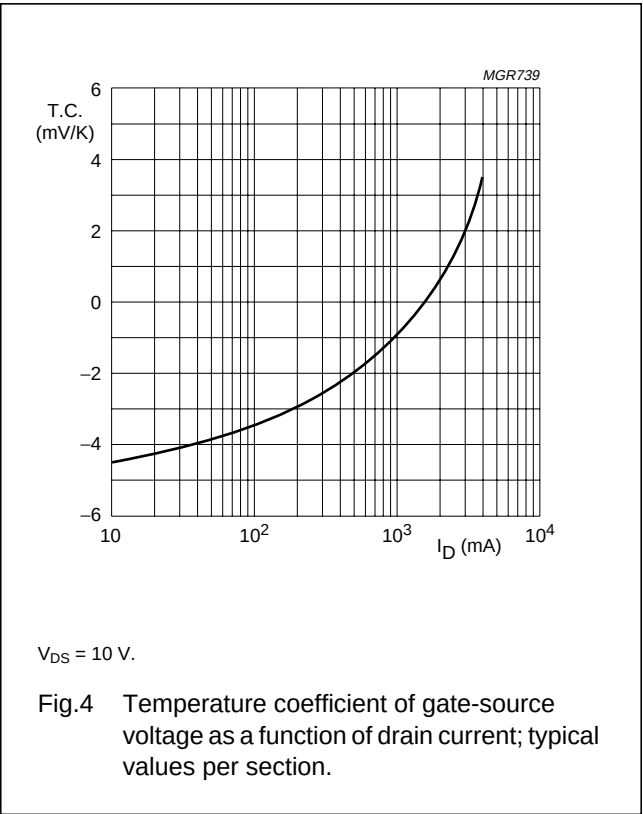
VHF push-pull power MOS transistor

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CHARACTERISTICS

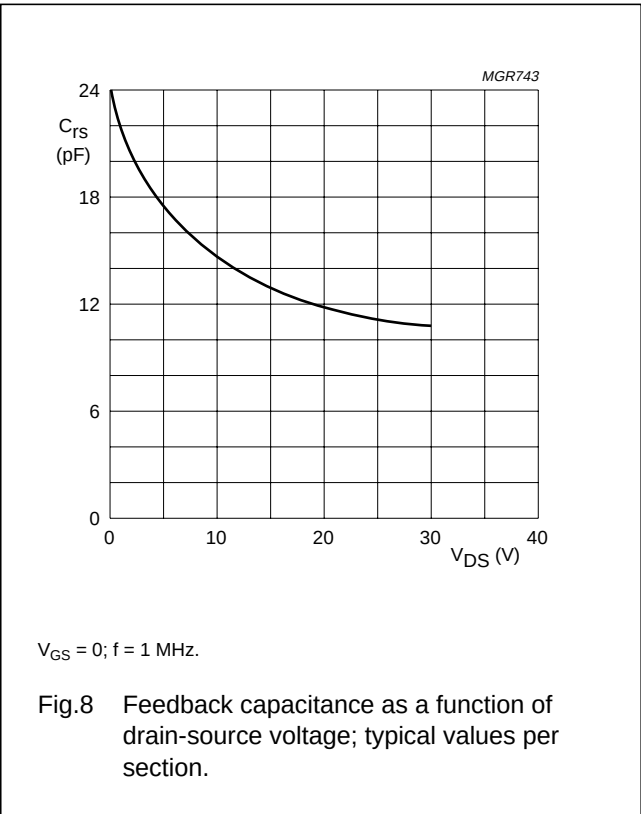
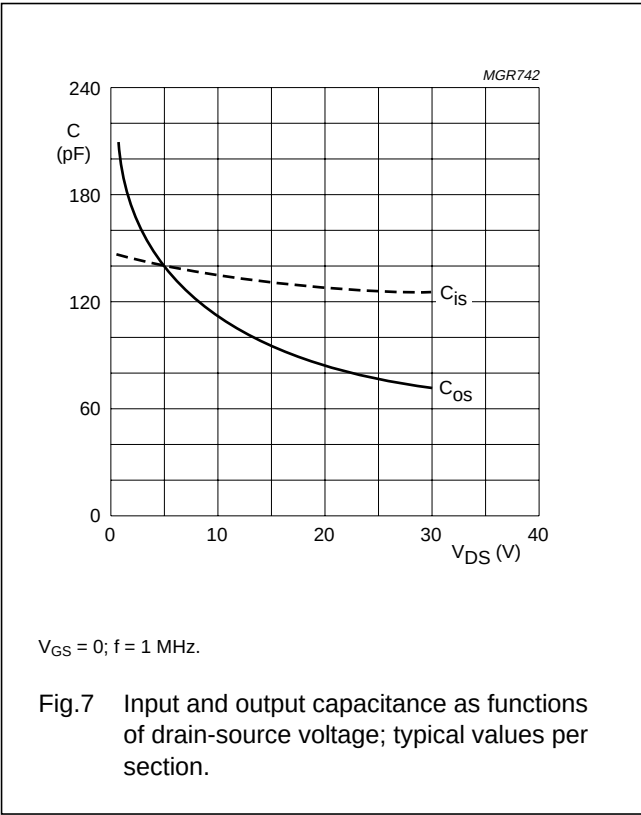
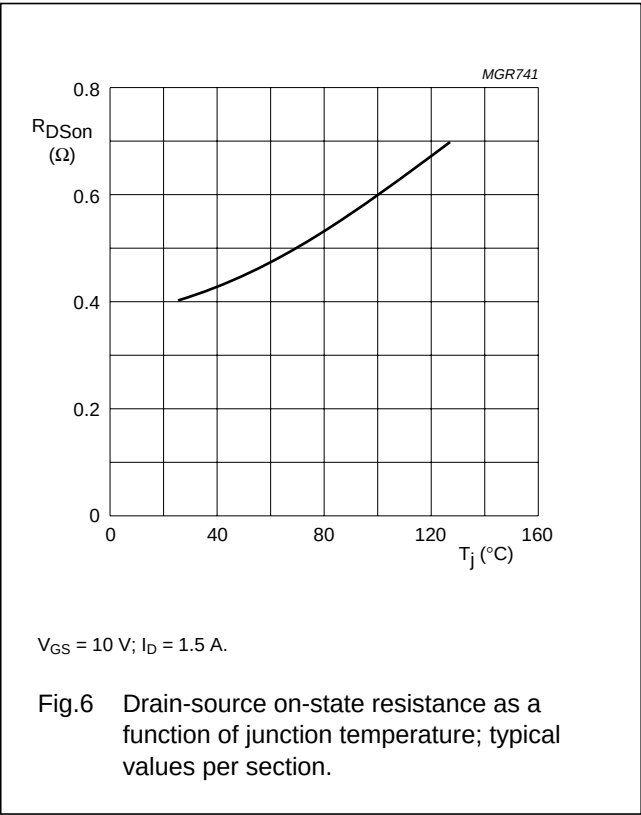
T_j = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Per transistor section						
V _{(BR)DSS}	drain-source breakdown voltage	V _{GS} = 0; I _D = 10 mA	65	–	–	V
I _{DSS}	drain-source leakage current	V _{GS} = 0; V _{DS} = 28 V	–	–	2	mA
I _{GSS}	gate-source leakage current	V _{GS} = ±20 V; V _{DS} = 0	–	–	1	µA
V _{GSth}	gate-source threshold voltage	I _D = 10 mA; V _{DS} = 10 V	2	–	4.5	V
g _{fs}	forward transconductance	I _D = 1.5 A; V _{DS} = 10 V	1.2	1.8	–	S
R _{DSon}	drain-source on-state resistance	I _D = 1.5 A; V _{GS} = 10 V	–	0.4	0.75	Ω
I _{DSX}	on-state drain current	V _{GS} = 10 V; V _{DS} = 10 V	–	10	–	A
C _{is}	input capacitance	V _{GS} = 0; V _{DS} = 28 V; f = 1 MHz	–	125	–	pF
C _{os}	output capacitance	V _{GS} = 0; V _{DS} = 28 V; f = 1 MHz	–	75	–	pF
C _{rs}	feedback capacitance	V _{GS} = 0; V _{DS} = 28 V; f = 1 MHz	–	11	–	pF



VHF push-pull power MOS transistor

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VHF push-pull power MOS transistor

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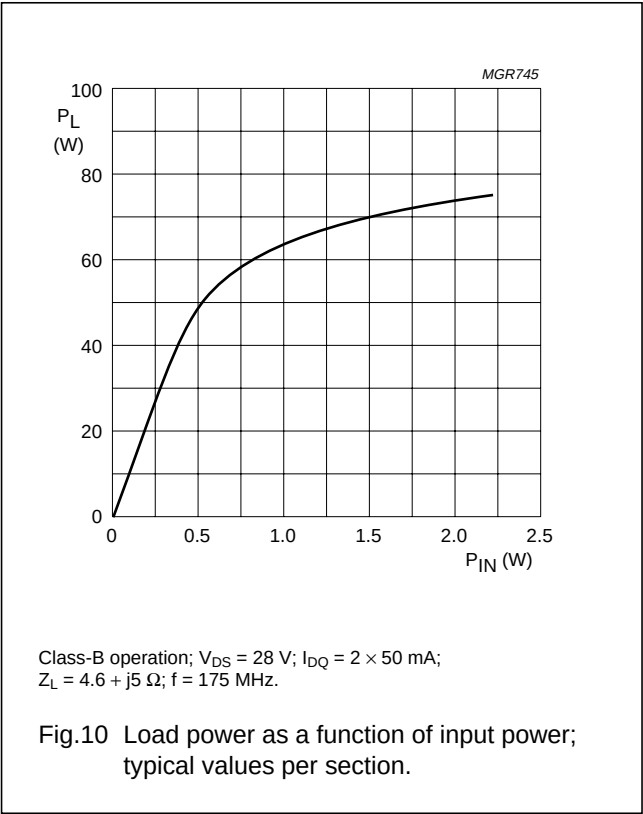
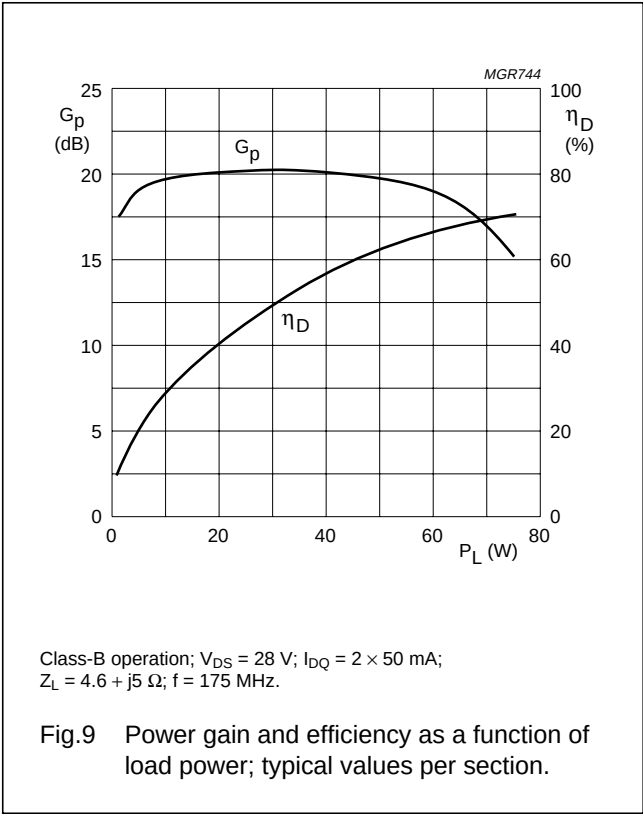
APPLICATION INFORMATION

RF performance in CW operation in a push-pull, common source, class-B circuit. $T_h = 25\text{ }^{\circ}\text{C}$; $R_{th\text{ mb-h}} = 0.25\text{ K/W}$; unless otherwise specified.

MODE OF OPERATION	f (MHz)	V _{DS} (V)	I _{DQ} (mA)	P _L (W)	G _p (dB)	η _D (%)
CW, class-B	175	28	2 × 50	60	>14 typ. 19	>55 typ. 65

Ruggedness in class-B operation

The BLF246B is capable of withstanding a load mismatch corresponding to VSWR = 50 : 1 through all phases under the following conditions: $V_{DS} = 28\text{ V}$; $f = 175\text{ MHz}$ at rated output power.



VHF push-pull power MOS transistor

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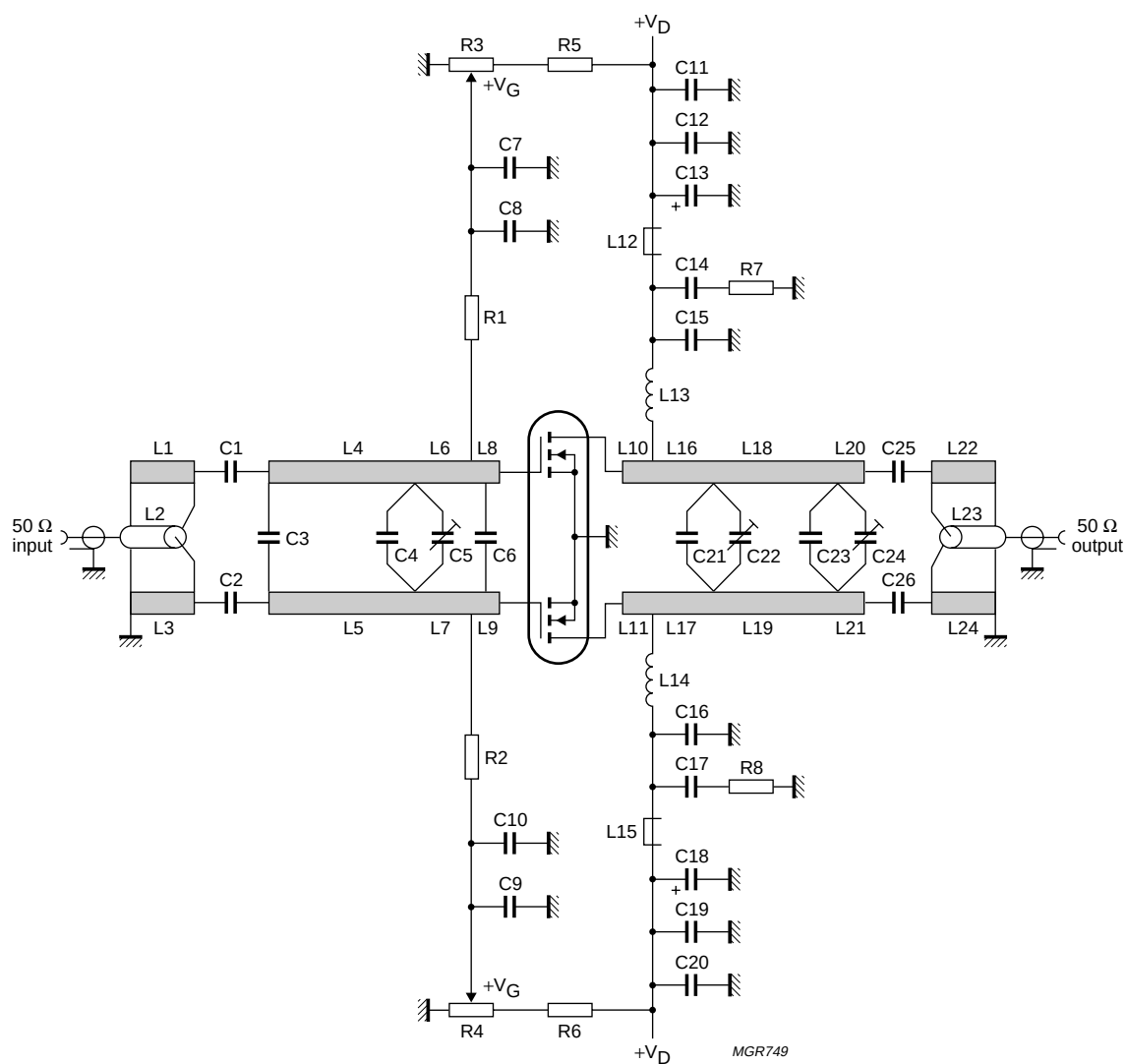
 $f = 175 \text{ MHz.}$

Fig.11 Test circuit for class-B operation.

VHF push-pull power MOS transistor

BLF246B

List of components class-B test circuit (see Figs 11 and 12)

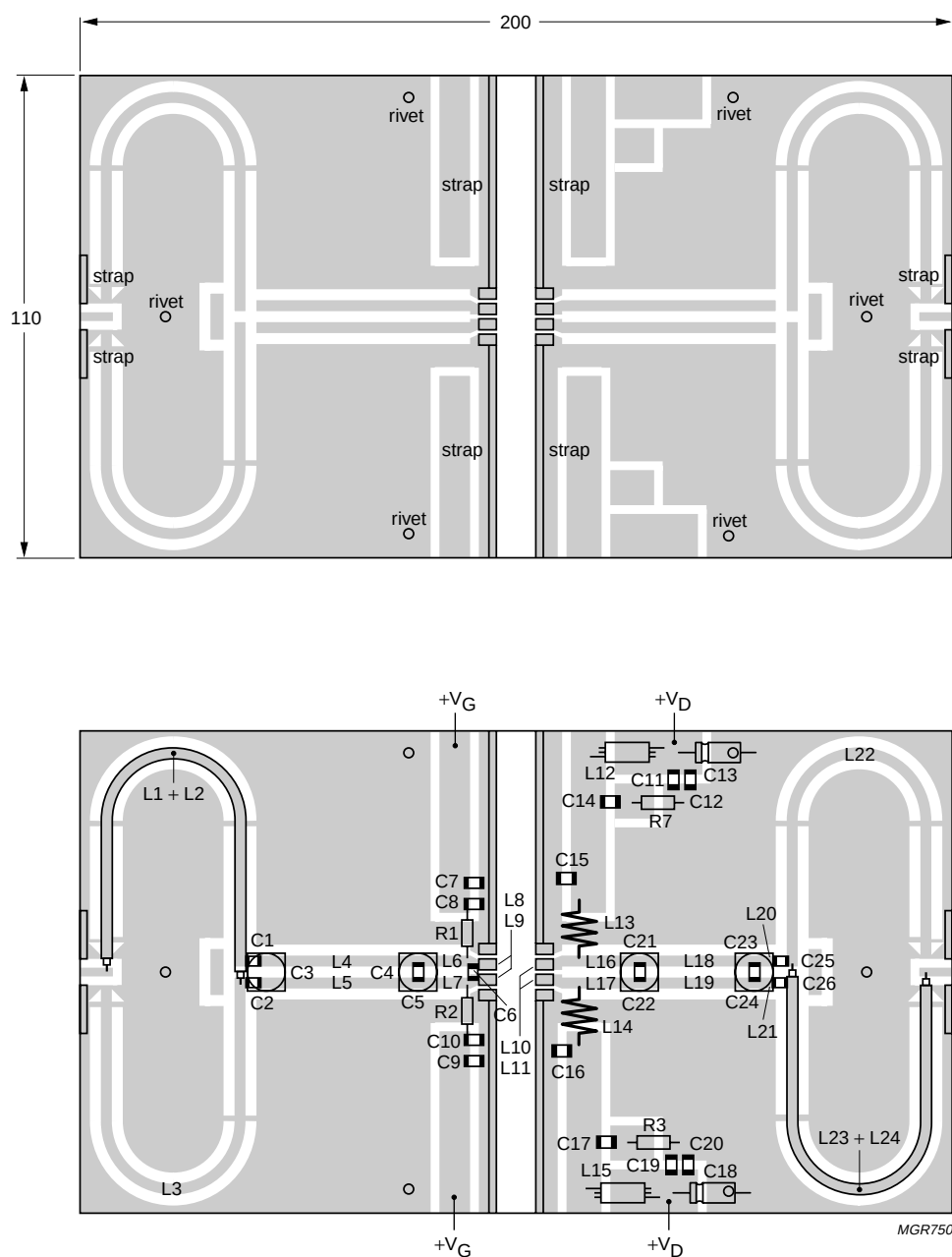
COMPONENT	DESCRIPTION	VALUE	DIMENSIONS	CATALOGUE No.
C1, C2, C25, C26	multilayer ceramic chip capacitor; note 1	91 pF		
C3	film dielectric trimmer	4 to 40 pF		2222 809 08002
C4	multilayer ceramic chip capacitor; note 1	180 pF		
C5, C22, C24	film dielectric trimmer	5 to 60 pF		2222 809 08003
C6	multilayer ceramic chip capacitor; note 1	100 pF		
C7, C9, C12, C14, C17, C19	multilayer ceramic chip capacitor; note 1	100 nF		2222 852 47104
C8, C10, C15, C16	multilayer ceramic chip capacitor; note 1	680 pF		
C11, C20	multilayer ceramic chip capacitor; note 1	10 nF		2222 852 47103
C13, C18	electrolytic capacitor	10 μ F, 63 V		
C21	multilayer ceramic chip capacitor; note 1	82 pF		
C23	multilayer ceramic chip capacitor; note 1	33 pF		
L1, L3, L22, L24	stripline; note 2	55 Ω	111 $\times$ 2.5 mm	
L2, L23	semi-rigid cable	50 Ω	length 111 mm ext. dia 2.2 mm	
L4, L5	stripline; note 2	50 Ω	6.5 $\times$ 2.8 mm	
L6, L7	stripline; note 2	50 Ω	35 $\times$ 2.8 mm	
L8, L9	stripline; note 2	50 Ω	5 $\times$ 2.8 mm	
L10, L11	stripline; note 2	50 Ω	9 $\times$ 2.8 mm	
L12, L15	grade 3B Ferroxcube wideband HF choke			4312 020 36642
L13, L14	4 turns enamelled 1 mm copper wire	50 nH	length 6.5 mm int. dia. 4 mm leads 2 $\times$ 5 mm	
L16, L17	stripline; note 2	50 Ω	17 $\times$ 2.8 mm	
L18, L19	stripline; note 2	50 Ω	26 $\times$ 2.8 mm	
L20, L21	stripline; note 2	50 Ω	4 $\times$ 2.8 mm	
R1, R2, R7, R8	metal film resistor	0.4 W, 10 Ω		
R3, R4	10 turns potentiometer	50 k Ω		
R5, R6	metal film resistor	0.4 W, 205 k Ω		

Notes

1. American Technical Ceramics (ATC) capacitor, type 100B or other capacitor of the same quality.
2. The striplines are on a double copper-clad printed-circuit board with epoxy glass dielectric ($\epsilon_r = 4.5$); thickness $\frac{1}{16}$ inch. The other side of the board is fully metallized and used as a ground plane. The ground planes on each side of the board are connected together by means of copper straps and hollow rivets.

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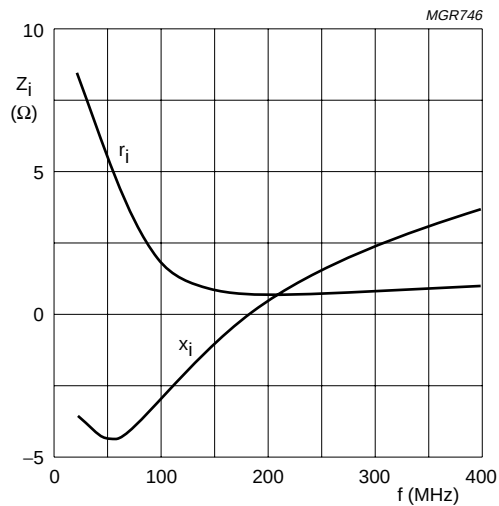
Dimensions in mm.

The circuit and components are situated on one side of the PTFE fibre-glass board, the other side being fully metallized, to serve as a ground plane. Earth connections are made by means of copper straps and hollow rivets for a direct contact between upper and lower sheets.

Fig.12 Component layout for 175 MHz class-B test circuit.

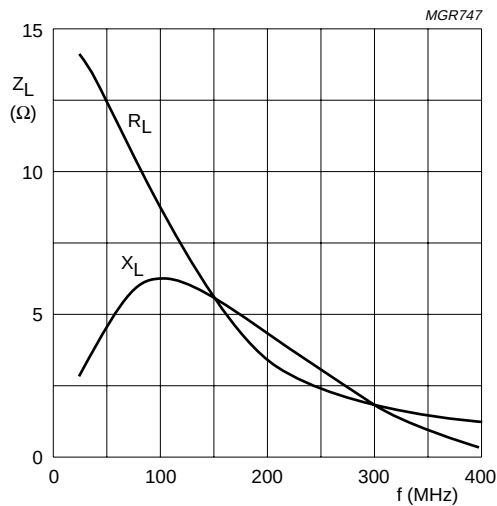
VHF push-pull power MOS transistor

BLF246B



Class-B operation; $V_{DS} = 28\text{ V}$; $I_{DQ} = 2 \times 50\text{ mA}$;
 $R_{GS} = 10\text{ }\Omega$; $P_L = 60\text{ W}$ (total device).

Fig.13 Input impedance as a function of frequency (series components); typical values per section.



Class-B operation; $V_{DS} = 28\text{ V}$; $I_{DQ} = 2 \times 50\text{ mA}$;
 $R_{GS} = 10\text{ }\Omega$; $P_L = 60\text{ W}$ (total device).

Fig.14 Load impedance as a function of frequency (series components); typical values per section.

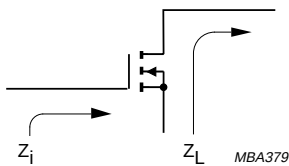
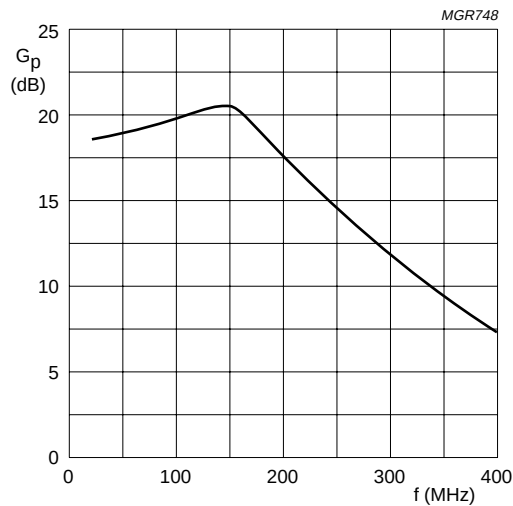


Fig.15 Definition of MOS impedance.



Class-B operation; $V_{DS} = 28\text{ V}$; $I_{DQ} = 2 \times 50\text{ mA}$;
 $R_{GS} = 10\text{ }\Omega$; $P_L = 60\text{ W}$ (total device).

Fig.16 Power gain as a function of frequency; typical values per section.

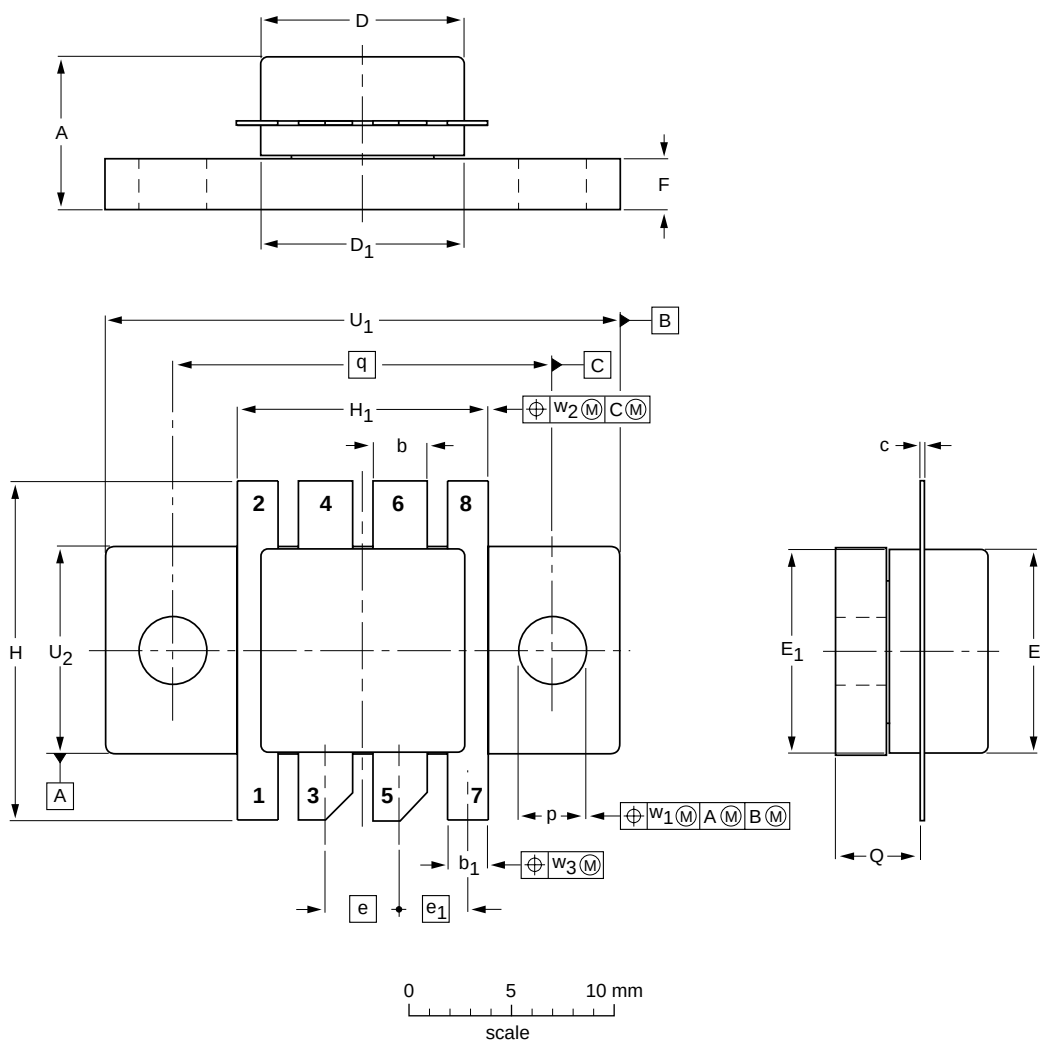
VHF push-pull power MOS transistor

BLF246B

PACKAGE OUTLINE

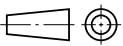
Flanged ceramic package; 2 mounting holes; 8 leads

SOT161A



DIMENSIONS (millimetre dimensions are derived from the original inch dimensions)

UNIT	A	b	b ₁	c	D	D ₁	E	E ₁	e	e ₁	F	H	H ₁	p	Q	q	U ₁	U ₂	w ₁	w ₂	w ₃
mm	7.27 6.47	2.93 2.66	2.04 1.77	0.18 0.10	10.22 10.00	10.21 9.94	10.21 10.00	10.21 9.94	3.80	3.50	2.70 2.08	16.81 16.21	12.83 12.57	3.33 3.07	4.32 4.06	18.42	24.97 24.71	10.34 10.08	0.25	0.51	0.25
inches	0.286 0.255	0.115 0.105	0.080 0.070	0.007 0.004	0.402 0.394	0.402 0.391	0.402 0.394	0.402 0.391	0.150	0.138	0.106 0.082	0.662 0.638	0.505 0.495	0.131 0.121	0.170 0.160	0.725	0.983 0.973	0.407 0.397	0.010	0.020	0.010

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT161A						99-03-29 99-10-04

VHF push-pull power MOS transistor

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DEFINITIONS

Data Sheet Status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	
Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
Application information	
Where application information is given, it is advisory and does not form part of the specification.	

LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.

VHF push-pull power MOS transistor

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NOTES

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NOTES

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Printed in The Netherlands

603516/05/pp16

Date of release: 2000 Feb 04

Document order number: 9397 750 06765

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